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(12) **United States Design Patent**
Mori et al.

(10) **Patent No.:** **US D803,803 S**

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(54) **FLEXIBLE PRINTED WIRING BOARD**

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(**) Term: **15 Years**

(21) Appl. No.: **29/586,571**

(57) **CLAIM**

The ornamental design for a flexible printed wiring board, as shown and described.

(22) Filed: **Dec. 5, 2016**

Related U.S. Application Data

DESCRIPTION

(62) Division of application No. 29/507,516, filed on Oct. 28, 2014, now Pat. No. Des. 785,575.

(30) **Foreign Application Priority Data**

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(51) **LOC (10) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**
USPC D13/155, 182; 174/68.1, 68.2, 68.3, 250, 174/253, 254, 255, 256, 257, 258, 260
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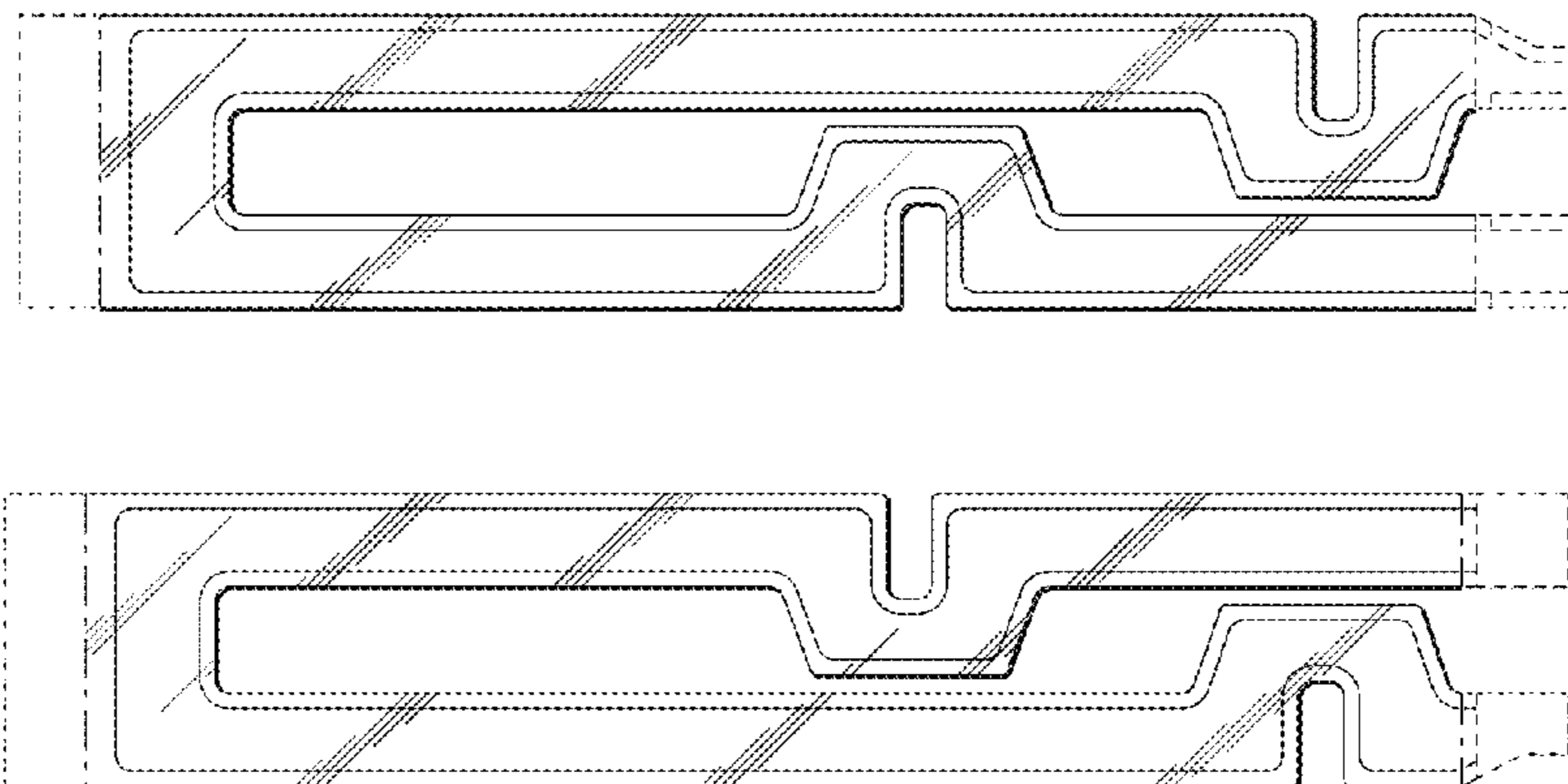
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FIG. 1 is a front view of a flexible printed wiring board showing our new design;
FIG. 2 is a rear view thereof;
FIG. 3 is a top plan view thereof;
FIG. 4 is a bottom plan view thereof;
FIG. 5 is a right side view thereof;
FIG. 6 is a left side view thereof;
FIG. 7 is an enlarged top plan view of the portion taken along line 7-7 in FIG. 3;
FIG. 8 is a bottom plan view of FIG. 7;
FIG. 9 is a front view of FIG. 7;
FIG. 10 is a rear view of FIG. 7;
FIG. 11 is a right side view of FIG. 7;
FIG. 12 is a left side view of FIG. 7; and,
FIG. 13 is a perspective view of FIG. 7.
The even dashed broken lines shown in the drawings represent portions of the flexible printed wiring board that form no part of the claimed design. The dashed-dot-dashed lines indicate a boundary between the claimed and unclaimed surface areas.

1 Claim, 4 Drawing Sheets



(30) Foreign Application Priority Data

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(58) Field of Classification Search

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 H05K 3/4015; H05K 3/0062; H05K 3/28;
 H05K 3/281; H05K 2201/0999; H05K
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See application file for complete search history.

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FIG.1



FIG.2

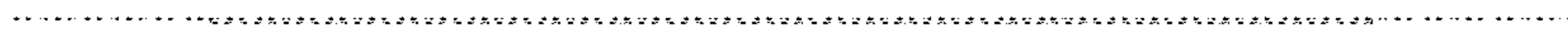


FIG.3



FIG.4

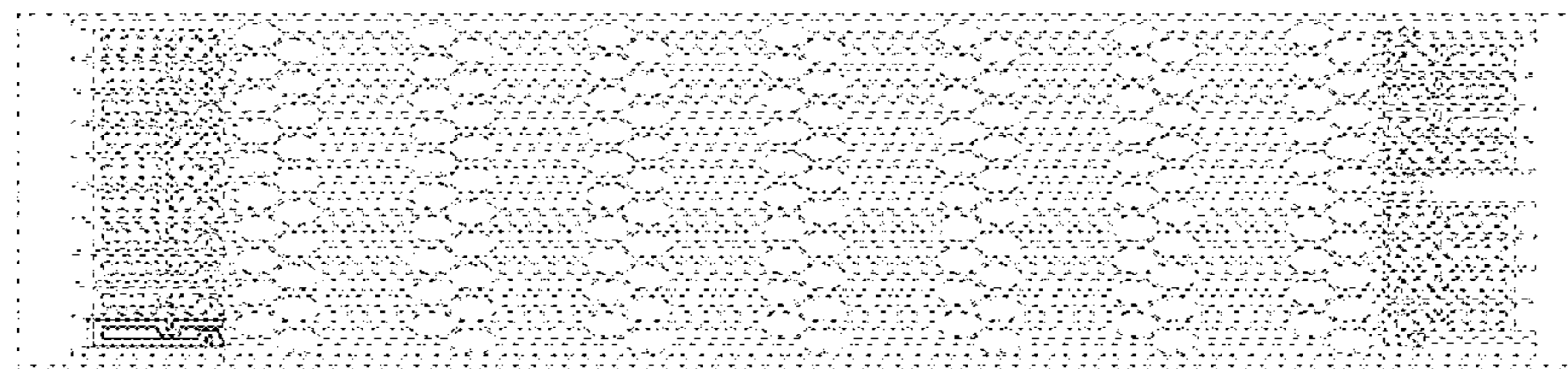


FIG.5

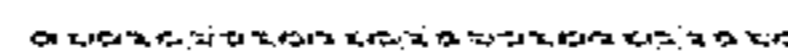


FIG.6



FIG.7

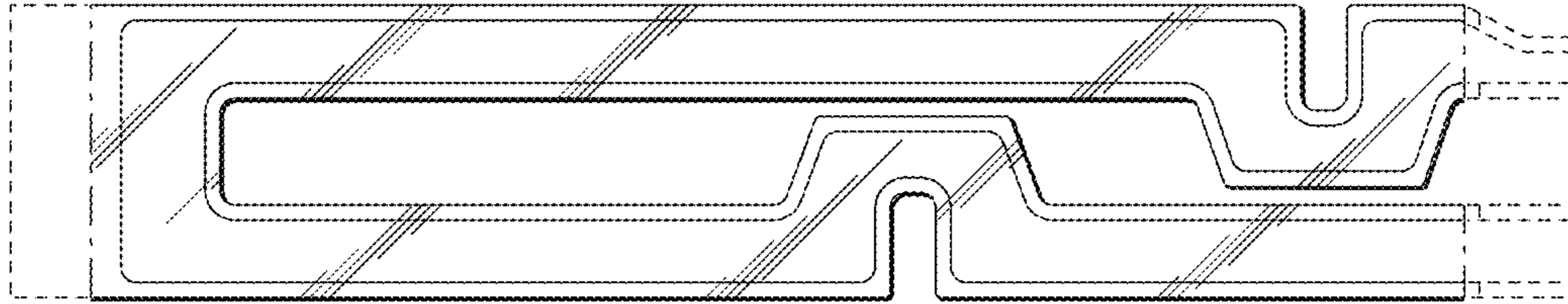


FIG.8

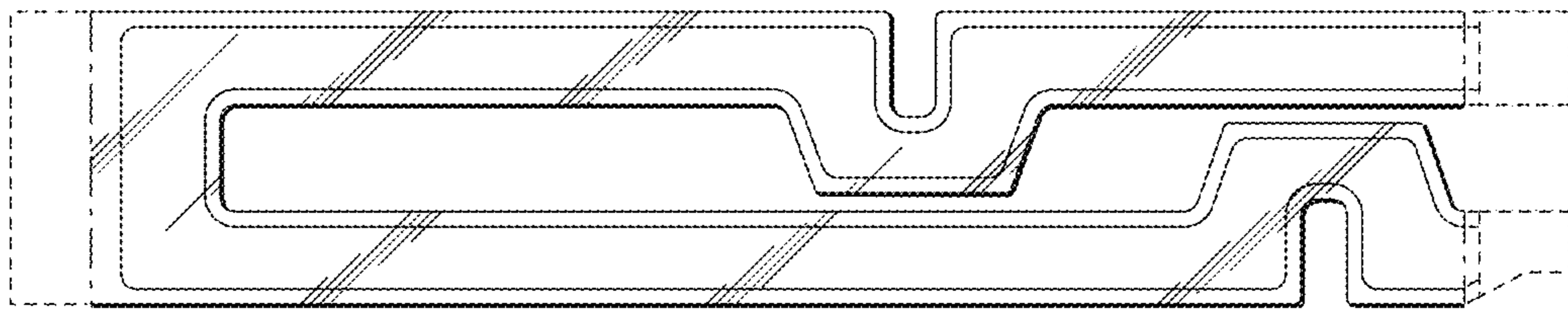


FIG.9



FIG.10



FIG.11

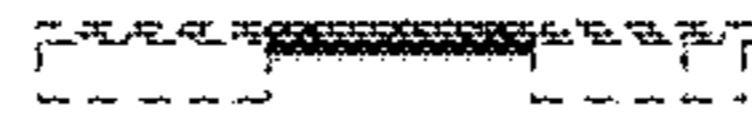


FIG.12

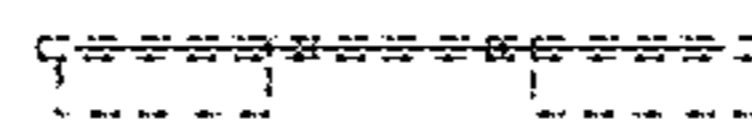


FIG.13

